

60 V / 50 V, 170 mA / 160 mA N/P-channel Trench MOSFET 18 January 2018 Product data sheet

### 1. General description

Complementary N/P-channel enhancement mode Field-Effect Transistor (FET) in a very small SOT363 (SC-88) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

### 2. Features and benefits

- Trench MOSFET technology
- Very fast switching
- ElectroStatic Discharge (ESD) protection

### 3. Applications

- Relay driver
- High-speed line driver
- Level shifter
- Power supply converter

### 4. Quick reference data

#### Table 1. Quick reference data

					_		
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
TR1 (N-chann	el)						
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> = 25 °C		-	-	60	V
I <sub>D</sub>	drain current	V <sub>GS</sub> = 10 V; T <sub>amb</sub> = 25 °C	[1]	-	-	170	mA
TR1 (N-chann	el), Static characteristic	S			·		
R <sub>DSon</sub>	drain-source on-state resistance	$V_{GS}$ = 10 V; I <sub>D</sub> = 100 mA; T <sub>j</sub> = 25 °C		-	3	4.5	Ω
TR2 (P-chann	el)	·					
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> = 25 °C		-	-	-50	V
I <sub>D</sub>	drain current	V <sub>GS</sub> = -10 V; T <sub>amb</sub> = 25 °C	[1]	-	-	-160	mA
TR2 (P-chann	el), Static characteristic	S					
R <sub>DSon</sub>	drain-source on-state resistance	V <sub>GS</sub> = -10 V; I <sub>D</sub> = -100 mA; T <sub>j</sub> = 25 °C		-	4.5	7.5	Ω

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 1 cm<sup>2</sup>.

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# 5. Pinning information

Table 2. Pinning information								
Pin	Symbol	Description	Simplified outline	Graphic symbol				
1	S1	source TR1	6 5 4	D1 D2				
2	G1	gate TR1						
3	D2	drain TR2	0					
4	S2	source TR2						
5	G2	gate TR2	TSSOP6 (SOT363)					
6	D1	drain TR1	_	S1 S2 017aaa262				

# 6. Ordering information

Table 3. Ordering information						
Type number	Package					
	Name	Description	Version			
NX6020CAKS	TSSOP6	plastic surface-mounted package; 6 leads	SOT363			

### 7. Marking

Table 4. Marking codes				
Type number	Marking code[1]			
NX6020CAKS	2A%			

[1] % = placeholder for manufacturing site code

### 8. Limiting values

#### Table 5. Limiting values

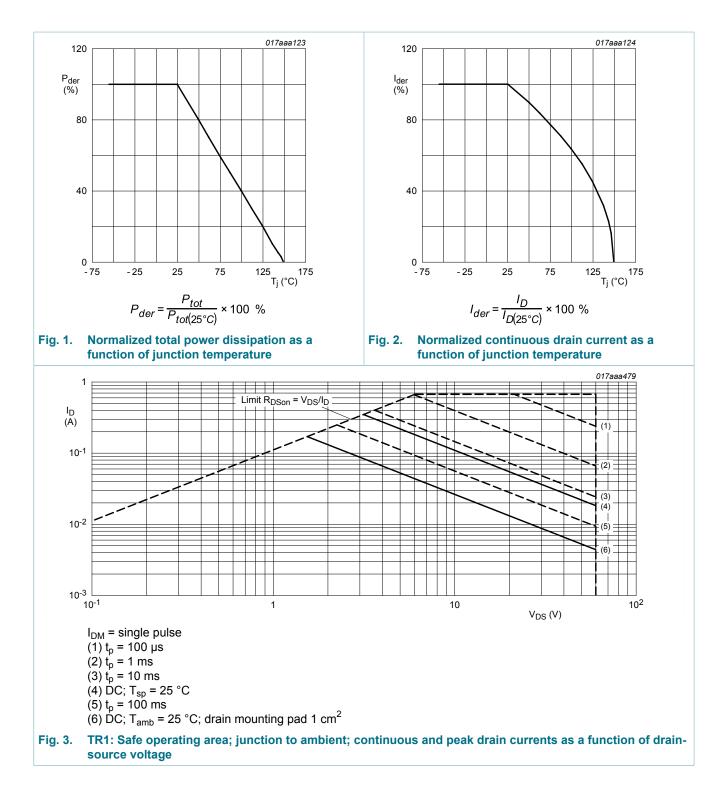
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Мах	Unit
TR1 (N-char	nnel)			·		
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> = 25 °C		-	60	V
V <sub>GS</sub>	gate-source voltage			-20	20	V
I <sub>D</sub>	drain current	V <sub>GS</sub> = 10 V; T <sub>amb</sub> = 25 °C	[1]	-	170	mA
		V <sub>GS</sub> = 10 V; T <sub>amb</sub> = 100 °C	[1]	-	100	mA
I <sub>DM</sub>	peak drain current	$T_{amb}$ = 25 °C; single pulse; $t_p \le 10 \ \mu s$		-	680	mA
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = 25 °C	[2]	-	220	mW
			[1]	-	255	mW
		T <sub>sp</sub> = 25 °C		-	1.06	W
TR2 (P-chan	inel)					
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> = 25 °C		-	-50	V
V <sub>GS</sub>	gate-source voltage			-20	20	V
I <sub>D</sub>	drain current	V <sub>GS</sub> = -10 V; T <sub>amb</sub> = 25 °C	[1]	-	-160	mA
		V <sub>GS</sub> = -10 V; T <sub>amb</sub> = 100 °C	[1]	-	-100	mA
I <sub>DM</sub>	peak drain current	$T_{amb}$ = 25 °C; single pulse; $t_p \le 10 \ \mu s$		-	-640	mA
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = 25 °C	[2]	-	280	mW
			[1]	-	320	mW
		T <sub>sp</sub> = 25 °C		-	990	mW
Per device						
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = 25 °C	[2]	-	330	mW
Tj	junction temperature			-55	150	°C
T <sub>amb</sub>	ambient temperature			-55	150	°C
T <sub>stg</sub>	storage temperature			-65	150	°C
TR1 (N-char	nnel), Source-drain diode	·				
I <sub>S</sub>	source current	T <sub>amb</sub> = 25 °C	[1]	-	170	mA
TR2 (P-chan	nnel), Source-drain diode	·				
I <sub>S</sub>	source current	T <sub>amb</sub> = 25 °C	[1]	-	-160	mA

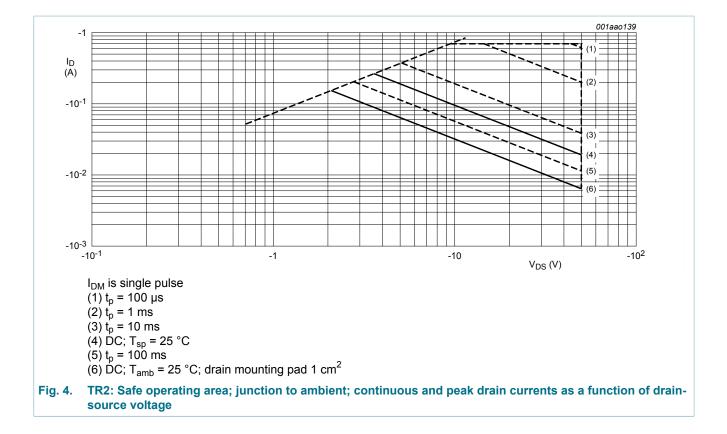
[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 1 cm<sup>2</sup>.

[2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper; tin-plated and standard footprint.

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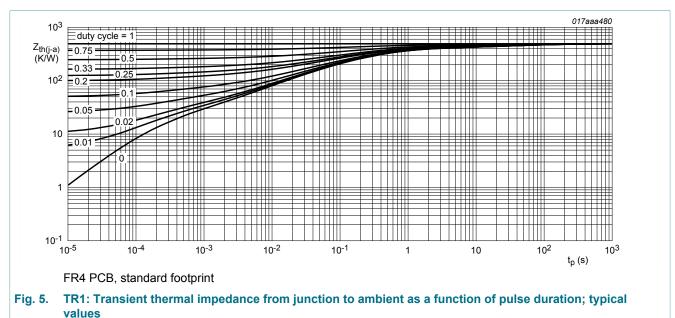


### 9. Thermal characteristics

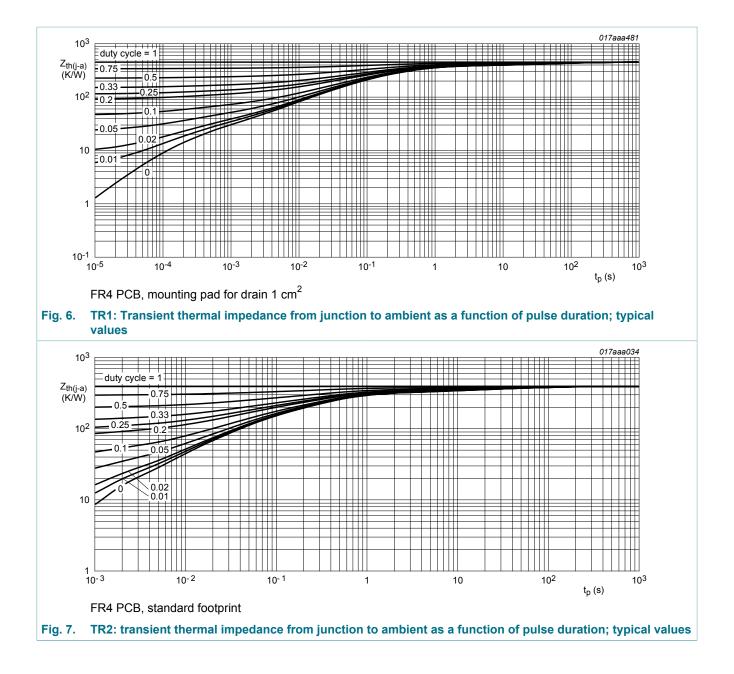
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
TR1 (N-cha	nnel)				- 1		
R <sub>th(j-a)</sub>	thermal resistance	in free air	[1]	-	500	560	K/W
from junction to ambient		[2]	-	450	480	K/W	
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point			-	-	115	K/W
TR2 (P-chai	nnel)					- 1	
R <sub>th(j-a)</sub> thermal resistar from junction to ambient	thermal resistance	in free air	[1]	-	390	445	K/W
			[2]	-	340	390	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point			-	-	130	K/W
Per device				1	1	1	
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air	[1]	-	-	300	K/W

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper; tin-plated and standard footprint.

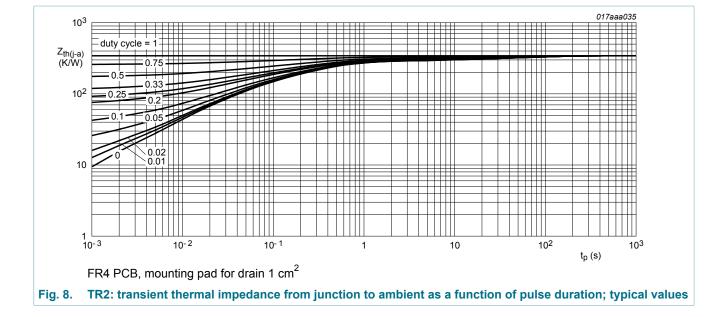
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 1 cm<sup>2</sup>.



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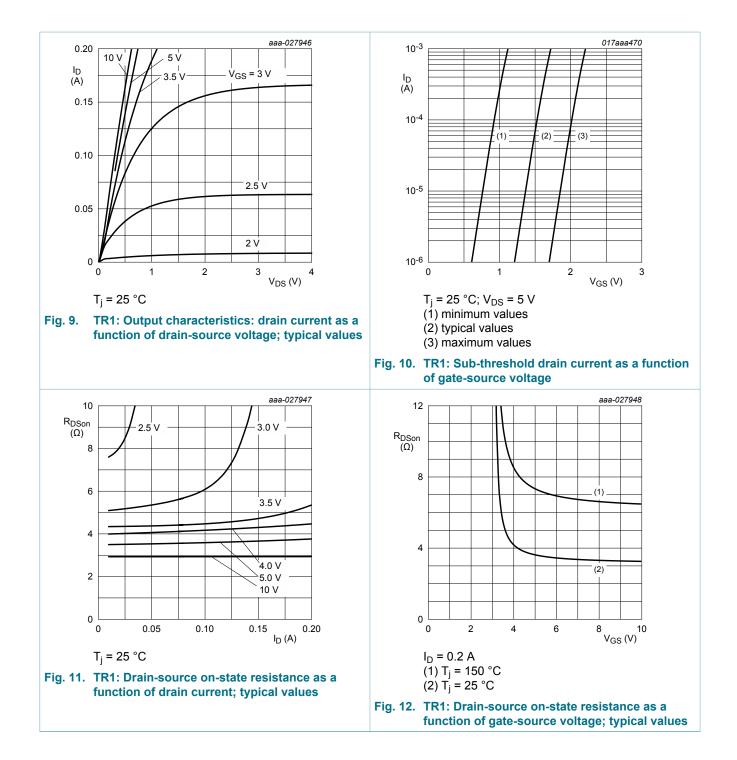


## **10. Characteristics**

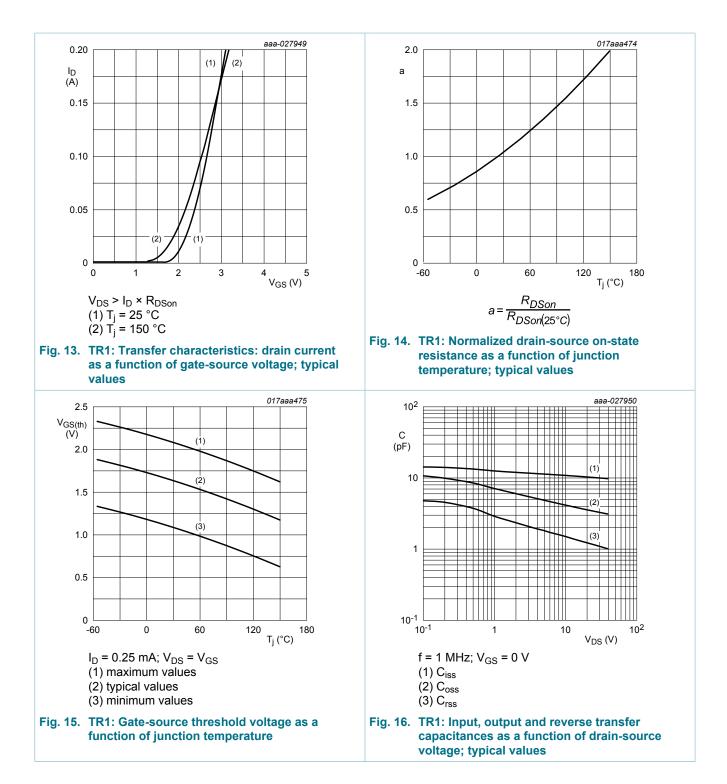
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
TR1 (N-chai	nnel), Static characteristic	S				
V <sub>(BR)DSS</sub>	drain-source breakdown voltage	I <sub>D</sub> = 250 μA; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C	60	-	-	V
V <sub>GSth</sub>	gate-source threshold voltage	I <sub>D</sub> = 250 μA; V <sub>DS</sub> =V <sub>GS</sub> ; T <sub>j</sub> = 25 °C	1.1	1.6	2.1	V
I <sub>DSS</sub>	drain leakage current	V <sub>DS</sub> = 60 V; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	-	1	μA
		V <sub>DS</sub> = 60 V; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 150 °C	-	-	10	μA
I <sub>GSS</sub>	gate leakage current	V <sub>GS</sub> = 20 V; V <sub>DS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	-	2	μA
		$V_{GS}$ = -20 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C	-	-	2	μA
		V <sub>GS</sub> = 10 V; V <sub>DS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	-	0.5	μA
		$V_{GS}$ = -10 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C	-	-	0.5	μA
		V <sub>GS</sub> = 5 V; V <sub>DS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	-	100	nA
		V <sub>GS</sub> = -5 V; V <sub>DS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	-	100	nA
	drain-source on-state	V <sub>GS</sub> = 10 V; I <sub>D</sub> = 100 mA; T <sub>j</sub> = 25 °C	-	3	4.5	Ω
	resistance	V <sub>GS</sub> = 10 V; I <sub>D</sub> = 100 mA; T <sub>j</sub> = 150 °C	-	6.2	9.2	Ω
		V <sub>GS</sub> = 5 V; I <sub>D</sub> = 100 mA; T <sub>j</sub> = 25 °C	-	3.7	5.2	Ω
9 <sub>fs</sub>	forward transconductance	$V_{DS}$ = 10 V; I <sub>D</sub> = 200 mA; T <sub>j</sub> = 25 °C	-	230	-	mS
TR2 (P-char	nnel), Static characteristic	S				
V <sub>(BR)DSS</sub>	drain-source breakdown voltage	I <sub>D</sub> = -10 μA; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C	-50	-	-	V
V <sub>GSth</sub>	gate-source threshold voltage	I <sub>D</sub> = -250 μA; V <sub>DS</sub> =V <sub>GS</sub> ; T <sub>j</sub> = 25 °C	-1.1	-1.6	-2.1	V
DSS	drain leakage current	$V_{DS}$ = -50 V; $V_{GS}$ = 0 V; $T_j$ = 25 °C	-	-	-1	μA
		V <sub>DS</sub> = -50 V; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 150 °C	-	-	-2	μA
GSS	gate leakage current	$V_{GS}$ = -20 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C	-	-	-10	μA
		V <sub>GS</sub> = 20 V; V <sub>DS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	-	-10	μA
R <sub>DSon</sub>	drain-source on-state	V <sub>GS</sub> = -10 V; I <sub>D</sub> = -100 mA; T <sub>j</sub> = 25 °C	-	4.5	7.5	Ω
	resistance	V <sub>GS</sub> = -10 V; I <sub>D</sub> = -100 mA; T <sub>j</sub> = 150 °C	-	8	13.5	Ω
		V <sub>GS</sub> = -5 V; I <sub>D</sub> = -100 mA; T <sub>j</sub> = 25 °C	-	5.7	8.5	Ω
9 <sub>fs</sub>	forward transconductance	$V_{DS}$ = -10 V; I <sub>D</sub> = -100 mA; T <sub>j</sub> = 25 °C	-	150	-	mS
TR1 (N-chai	nnel), Dynamic characteris	stics	1			
Q <sub>G(tot)</sub>	total gate charge	$V_{DS}$ = 30 V; I <sub>D</sub> = 200 mA; V <sub>GS</sub> = 4.5 V;	-	0.33	0.43	nC
Q <sub>GS</sub>	gate-source charge	T <sub>j</sub> = 25 °C	-	0.12	-	nC
Q <sub>GD</sub>	gate-drain charge		-	0.09	-	nC

# NX6020CAKS

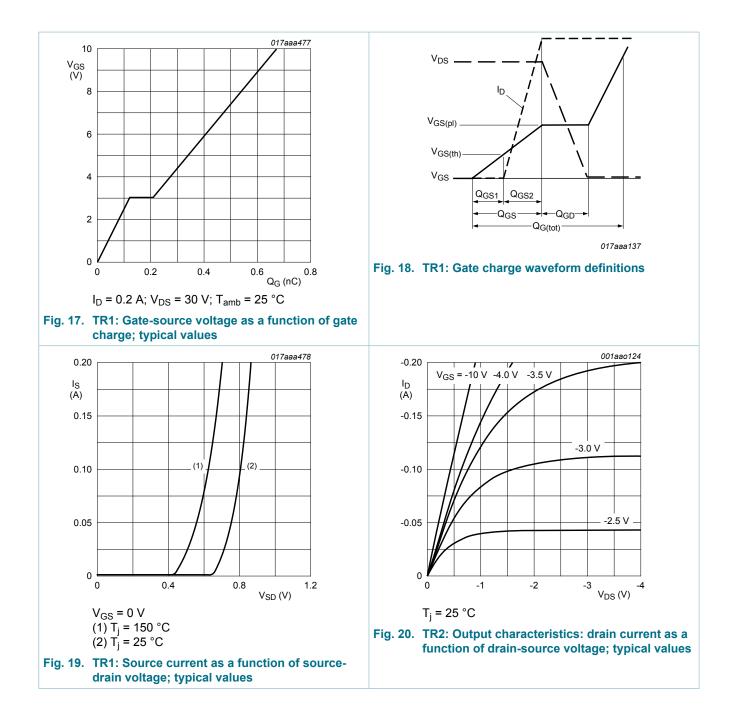
Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
C <sub>iss</sub>	input capacitance	V <sub>DS</sub> = 10 V; f = 1 MHz; V <sub>GS</sub> = 0 V;		-	11	17	pF
C <sub>oss</sub>	output capacitance	T <sub>j</sub> = 25 °C		-	3.4	-	pF
C <sub>rss</sub>	reverse transfer capacitance			-	1.4	-	pF
t <sub>d(on)</sub>	turn-on delay time	$V_{DS}$ = 40 V; $R_{L}$ = 250 $\Omega$ ; $V_{GS}$ = 10 V;		-	6	12	ns
t <sub>r</sub>	rise time	$R_{G(ext)} = 6 \Omega; T_j = 25 °C$		-	7	-	ns
t <sub>d(off)</sub>	turn-off delay time			-	20	40	ns
t <sub>f</sub>	fall time			-	14	-	ns
TR2 (P-chai	nnel), Dynamic character	istics					
Q <sub>G(tot)</sub>	total gate charge	$V_{DS}$ = -25 V; $I_D$ = -200 mA; $V_{GS}$ = -5 V; $T_j$ = 25 °C		-	0.26	0.35	nC
Q <sub>GS</sub>	gate-source charge			-	0.12	-	nC
Q <sub>GD</sub>	gate-drain charge			-	0.09	-	nC
C <sub>iss</sub>	input capacitance	V <sub>DS</sub> = -25 V; f = 1 MHz; V <sub>GS</sub> = 0 V;		-	24	36	pF
C <sub>oss</sub>	output capacitance	T <sub>j</sub> = 25 °C		-	4.5	-	pF
C <sub>rss</sub>	reverse transfer capacitance			-	1.3	-	pF
t <sub>d(on)</sub>	turn-on delay time	$V_{DS}$ = -30 V; R <sub>L</sub> = 250 Ω; V <sub>GS</sub> = -10 V;		-	13	26	ns
t <sub>r</sub>	rise time	$R_{G(ext)} = 6 \Omega; T_j = 25 °C$		-	11	-	ns
t <sub>d(off)</sub>	turn-off delay time			-	48	96	ns
t <sub>f</sub>	fall time			-	25	-	ns
TR1 (N-cha	nnel), Source-drain diode	characteristics					
V <sub>SD</sub>	source-drain voltage	$I_{S}$ = 115 mA; $V_{GS}$ = 0 V; $T_{j}$ = 25 °C		0.47	0.7	1.2	V
TR2 (P-cha	nnel), Source-drain diode	characteristics					
V <sub>SD</sub>	source-drain voltage	$I_{S}$ = -115 mA; $V_{GS}$ = 0 V; $T_{j}$ = 25 °C		-0.48	-0.85	-1.2	V
-							



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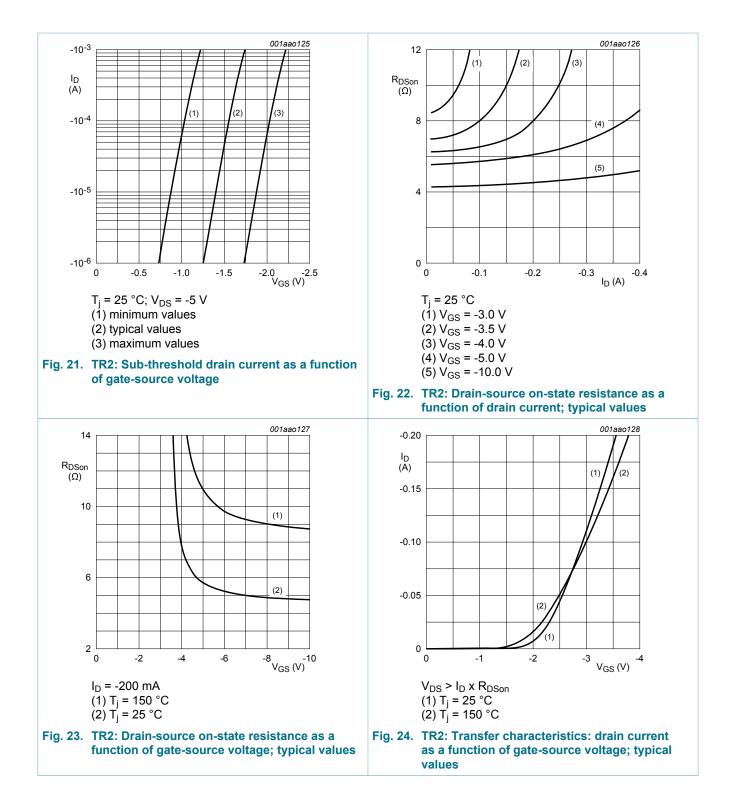


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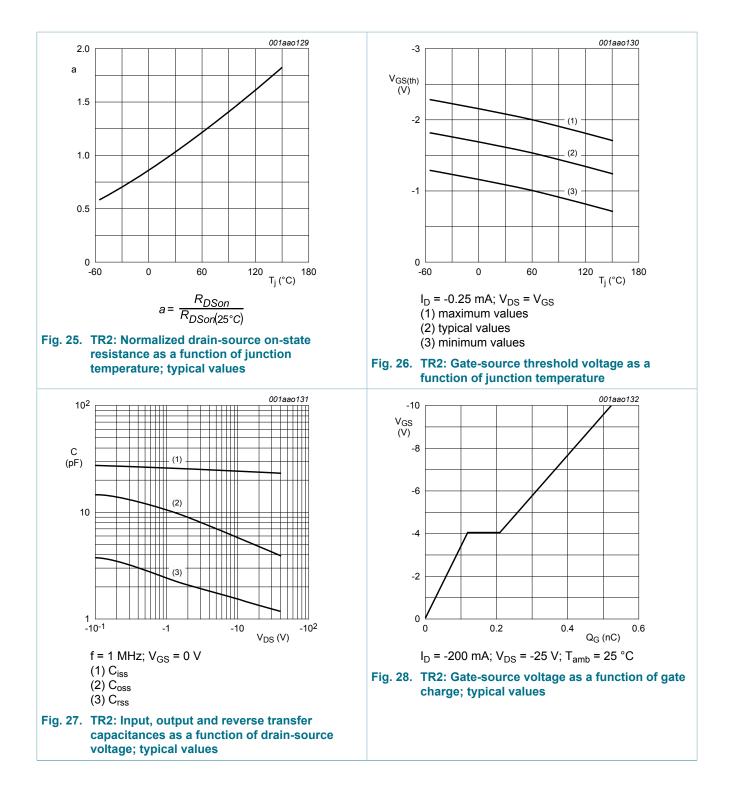
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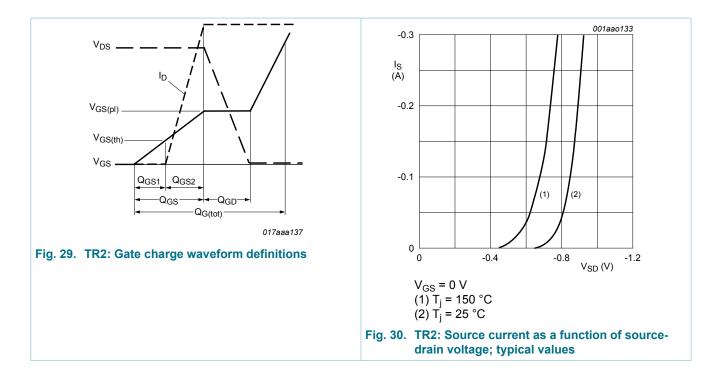
14 / 22

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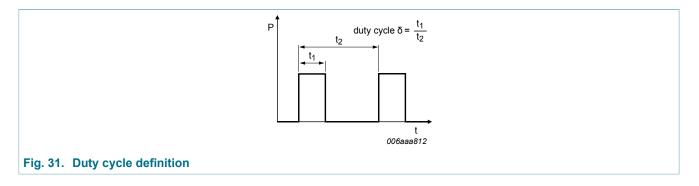


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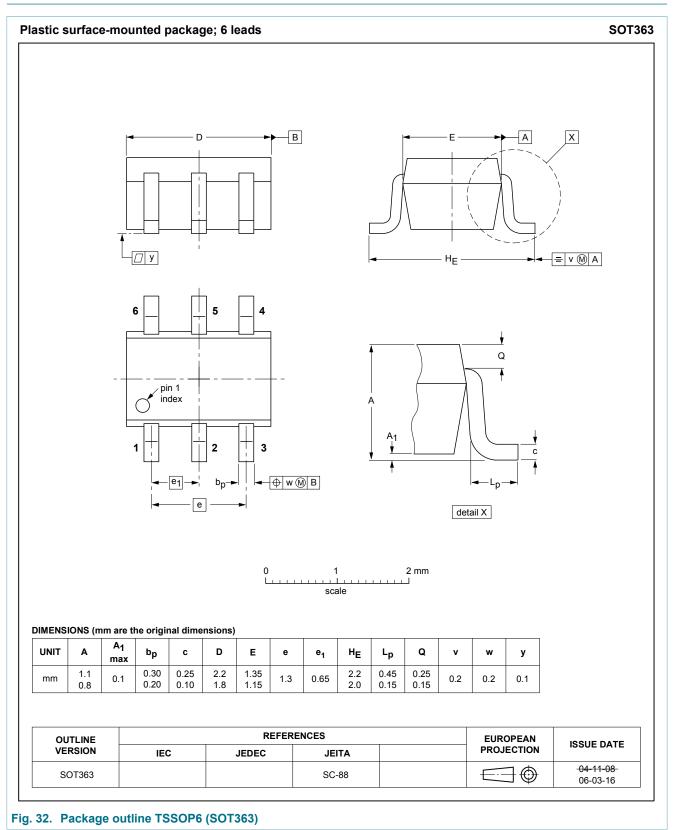


# 11. Test information



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### 12. Package outline

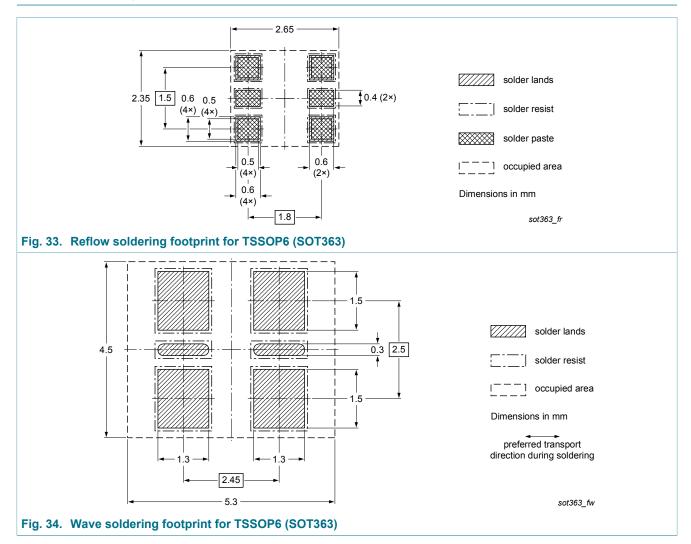


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### 60 V / 50 V, 170 mA / 160 mA N/P-channel Trench MOSFET

### 13. Soldering



18 / 22

# 14. Revision history

Table 8. Revision history								
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes				
NX6020CAKS v.2	20180118	Product data sheet	-	NX6020CAKS v.1				
Modifications:		<ul> <li>Data sheet status changed to Product.</li> <li>Section: Limiting values, ESD maximum rating removed.</li> </ul>						
NX6020CAKS v.1	20171220	Preliminary data sheet	-	-				

#### 60 V / 50 V, 170 mA / 160 mA N/P-channel Trench MOSFET

## 15. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

 Please consult the most recently issued document before initiating or completing a design.

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NX6020CAKS

18 January 2018

#### 60 V / 50 V, 170 mA / 160 mA N/P-channel Trench MOSFET

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NX6020CAKS

#### 60 V / 50 V, 170 mA / 160 mA N/P-channel Trench MOSFET

# 16. Contents

1.	General description	1
2.	Features and benefits	1
3.	Applications	1
4.	Quick reference data	1
5.	Pinning information	2
6.	Ordering information	2
7.	Marking	2
8.	Limiting values	3
9.	Thermal characteristics	6
10	. Characteristics	9
11.	. Test information	16
12	. Package outline	17
13	. Soldering	18
14	. Revision history	19
15	. Legal information	20

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